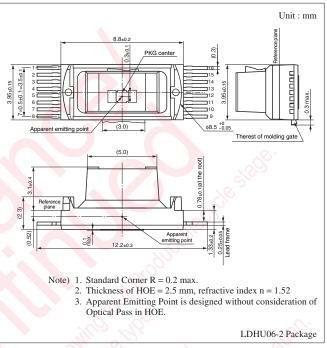
HUH7282/HUH7283

For CD-R/RW Drivers Hologram Unit

For optical information processing (Recordable \times 16 speed + readable \times 48 speed)

Features

- It is developed real with window structured high power laser diode, and realized high speed recording
- 16 × writing/48 × reading of CD-R/RW possible
- Thin (4.0 mm) package realizes thin and simple pick-up
- Applications
- CD-R/RW
- Tracking error signal output pin count
- HUH7282: 4 pins HUH7283: 2 pins

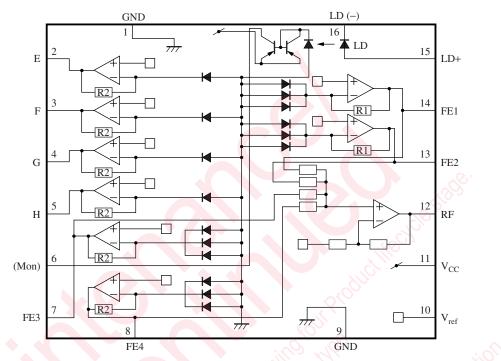


Absolute Maximum Ratings

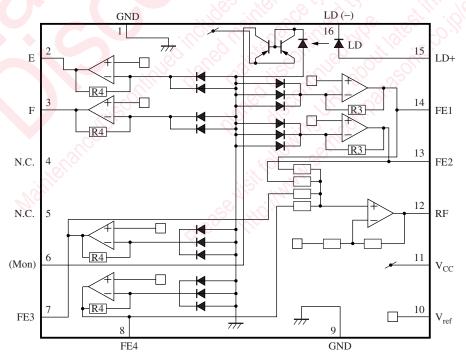
Parameter	Symbol	Rating	Unit	
Radiant power	Po	90 (CW), 135 (pulse)	mW	
Reverse voltage	V _{R(LD)}	1.5	V	
Supply voltage	V _{cc}	6	V	
Reference voltage	V _{ref}	+1.5 to +2.3	V	
Operating ambient temperature	T _{opr}	-10 to +60	Ч°С	
Storage temperature	T _{stg}	-40 to +85	°C	
Mainter			se visit	

Block Diagrams

• HUH7282



• HUH7283



Pin Descriptions

• HUH7282

Pin No.	Description	Pin No.	Description
1	GND	9	GND
2	E Signal out (V _E)	10	V _{ref}
3	F Signal out (V _F)	11	V _{CC}
4	G Signal out (V _G)	12	RF
5	H Signal out (V _H)	13	FE2 Signal out (V _{FE2})
6 *	(Mon. out) value not guaranteed	-14	FE1 Signal out (V _{FE1})
7	FE3 Signal out (V _{FE3})	15	LD(+)
8	FE4 Signal out (V _{FE4})	16	LD(-)

Note) *: The pin 6 must be connected to GND level.

• HUH7283

Pin No.	Description	Pin No.	Description
1	GND	9	GND
2	E Signal out (V _E)	10	V _{ref}
3	F Signal out (V _F)	11	V _{CC}
4	N.C.	12	RF
5	N.C.	13	FE2 Signal out (V _{FE2})
6 *	(Mon. out) value not guaranteed	14	FE1 Signal out (V _{FE1})
7	FE3 Signal out (V _{FE3})	15	LD(+)
8	FE4 Signal out (V _{FE4})	16	LD(-)
	pin 6 must be connected to GND level.		
Electro	-Optical Characteristics		

Electro-Optical Characteristics

• Unit characteristic specifications $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Threshold current	I _{th}	CW	15	26	40	mA
Operating current	I _{OP}	$CW, P_0 = 80 \text{ mW}$	85	105	125	mA
Operating voltage	V _{OP}	ist was	1.6	1.9	2.5	V
Oscillation wavelength	λ		779	785	791	nm
Focus error signal amplitude	V _{FE}	$P_{LO} = 0.8 \text{ mW}, V_{CC} = 5 \text{ V}, V_{ref} = 1.65 \text{ V}$	120	200	280	mV
Focus error signal balance	B_{FE}		-20	0	+20	%
Main beam signal amount	V _{TE}		150	255	360	mV
Main beam signal balance	B _{TE}		-30	0	+30	%
Sub beam signal amount	V _{TC}		120	205	290	mV
RF signal amount	V _{RF}		355	590	825	mV

▲Caution for Safety

This product contains Gallium Arsenide (GaAs).

GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

Do not touch or look into the laser beam directly.

The laser beam may cause injury to the eye or skin, or loss of eyesight.

Request for your special attention and precautions in using the technical information and semiconductors described in this book

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 - systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - Any applications other than the standard applications intended.

/!\DANGER

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- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
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